

10/737,231

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| L1 | 2838 | wafer\$3 and conductive\$4 and rim\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/07/18 16:14 |
| L2 | 790 | L1 and MEMS | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/07/18 16:07 |
| L6 | 186 | wafer\$3 and (conductive with rim) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/07/18 16:53 |
| L7 | 1375 | wafer\$3 and (conductive with (rim or curve or circular\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/07/18 16:54 |
| L8 | 978 | wafer\$3 and (connection\$4 with (rim or curve or circular\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/07/18 16:54 |